ALPHA & OMEGA SEMICONDUCTOR

AOT2142L/AOTF2142L

40V N-Channel MOSFET

General Description

- Trench Power MV MOSFET technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Optimized for fast-switching applications

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

Product Summary

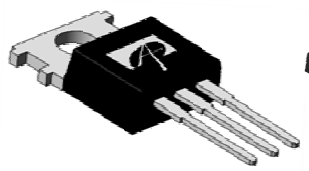
V_{DS}	40V
I_D (at V_{GS}=10V)	120A / 112A
$R_{DS(ON)}$ (at V_{GS}=10V)	< 1.9mΩ
$R_{DS(ON)}$ (at V_{GS}=4.5V)	< 2.5mΩ

100% UIS Tested
100% Rg Tested

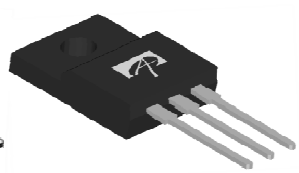
Green Product

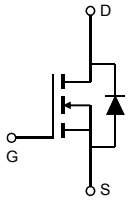
Top View

TO-220 AOT2142L



TO-220F AOTF2142L





Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT2142L	TO-220	Tube	1000
AOTF2142L	TO-220F	Tube	1000

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	AOT2142L(Max)	AOTF2142L(Max)	Units
Drain-Source Voltage		V_{DS}	40		V
Gate-Source Voltage		V_{GS}	±20		V
Continuous Drain Current	T_C=25°C	I_D	120 G	112	A
	T_C=100°C		120 G	78	
Pulsed Drain Current C		I_{DM}	600		
Continuous Drain Current	T_A=25°C	I_{DSM}	50		A
	T_A=70°C		40		
Avalanche Current C		I_{AS}	60		A
Avalanche energy	L=0.3mH C	E_{AS}	540		mJ
V_{DS} Spike	10µs	V_{SPIKE}	48		V
Power Dissipation B	T_C=25°C	P_D	312	41	W
	T_C=100°C		156	20	
Power Dissipation A	T_A=25°C	P_{DSM}	8.3		W
	T_A=70°C		5.3		
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 175		°C

Thermal Characteristics

Parameter		Symbol	AOT2142L(Max)	AOTF2142L(Max)	Units
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	15	15	°C/W
Maximum Junction-to-Ambient A D	Steady-State		60	60	°C/W
Maximum Junction-to-Case	Steady-State	$R_{\theta JC}$	0.48	3.6	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=250µA, V_{GS}=0V	40			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=40V, V_{GS}=0V			1	µA
		T_J=55°C			5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±20V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250µA	1.3	1.8	2.3	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=20A		1.55	1.9	mΩ
		T_J=125°C		2.25	2.8	
		V_{GS}=4.5V, I_D=20A		1.95	2.5	mΩ
g_{FS}	Forward Transconductance	V_{DS}=5V, I_D=20A		100		S
V_{SD}	Diode Forward Voltage	I_S=1A,V_{GS}=0V		0.66	1	V
I_S	Maximum Body-Diode Continuous Current [G] (AOT2142L)				120	A
I_S	Maximum Body-Diode Continuous Current (AOTF2142L)				50	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=20V, f=1MHz		8320		pF
C_{oss}	Output Capacitance			1438		pF
C_{rss}	Reverse Transfer Capacitance			85		pF
R_g	Gate resistance	f=1MHz	0.5	1.15	1.8	Ω
SWITCHING PARAMETERS						
Q_g(10V)	Total Gate Charge	V_{GS}=10V, V_{DS}=20V, I_D=20A		100		nC
Q_g(4.5V)	Total Gate Charge			45		nC
Q_{gs}	Gate Source Charge			25		nC
Q_{gd}	Gate Drain Charge			7		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DS}=20V, R_L=1.0Ω, R_{GEN}=3Ω		19		ns
t_r	Turn-On Rise Time			7		ns
$t_{D(off)}$	Turn-Off DelayTime			69		ns
t_f	Turn-Off Fall Time			10		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=20A, dI/dt=400A/µs		26		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=20A, dI/dt=400A/µs		83		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on $R_{\theta JA}$ t≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175° C may be used if the PCB allows it.
B. The power dissipation P_D is based on $T_{J(MAX)}$=175° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
C. Single pulse width limited by junction temperature $T_{J(MAX)}$=175° C.
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$=175° C. The SOA curve provides a single pulse rating.
G. The maximum current rating is package limited.
H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

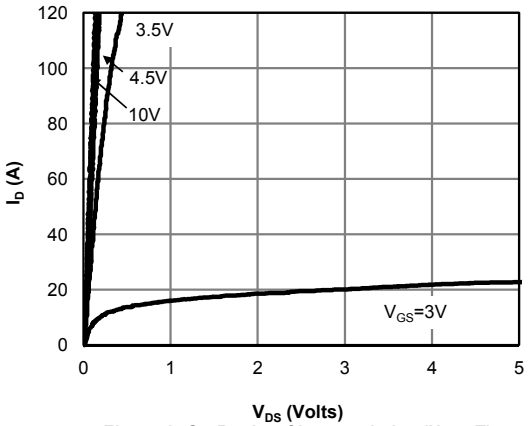


Figure 1: On-Region Characteristics (Note E)

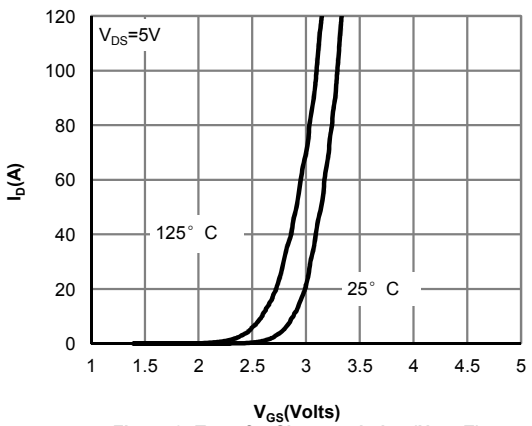


Figure 2: Transfer Characteristics (Note E)

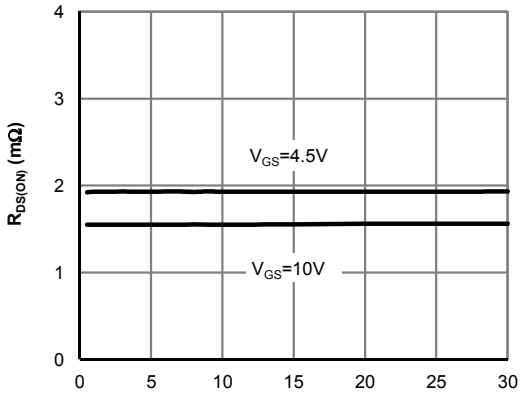


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

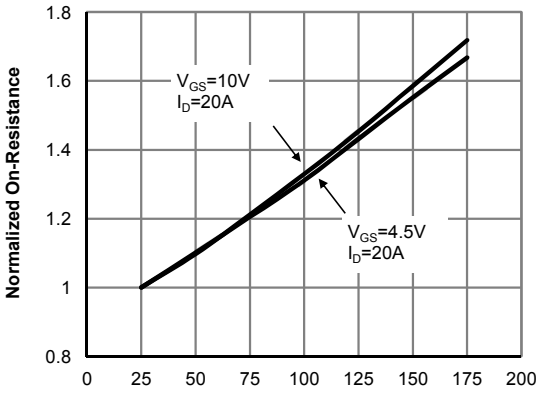


Figure 4: On-Resistance vs. Junction Temperature (Note E)

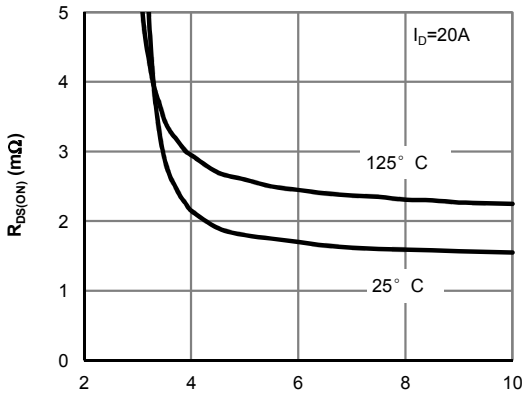


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

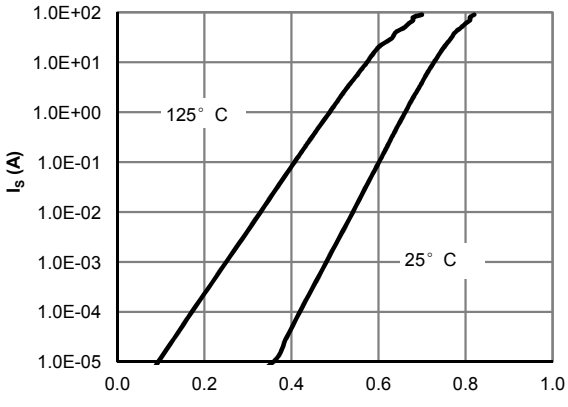


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

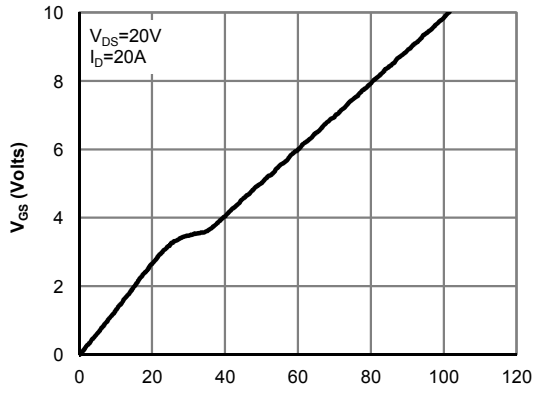


Figure 7: Gate-Charge Characteristics

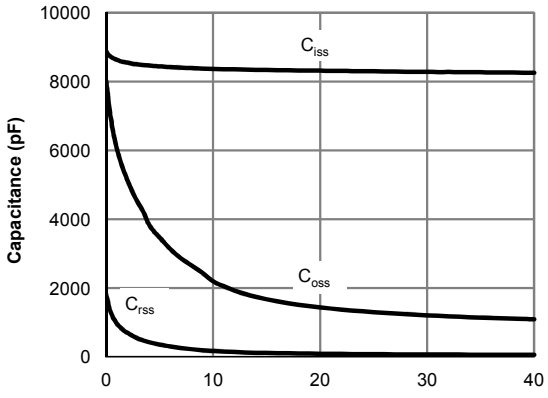


Figure 8: Capacitance Characteristics

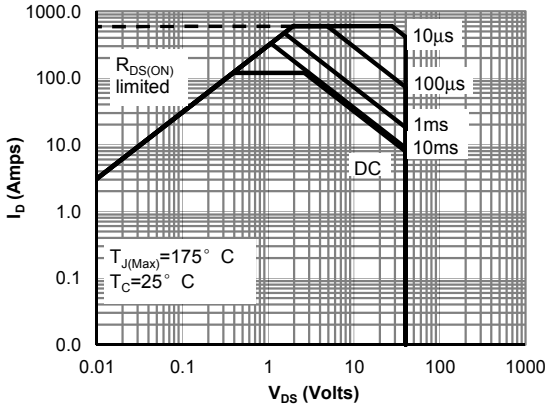


Figure 9: Maximum Forward Biased Safe Operating Area for AOT2142L (Note F)

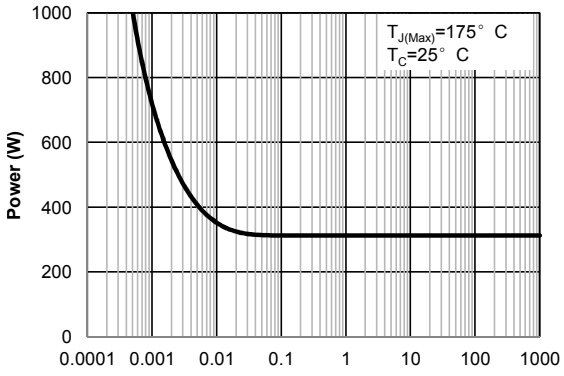


Figure 10: Single Pulse Power Rating Junction-to-Case for AOT2142L (Note F)

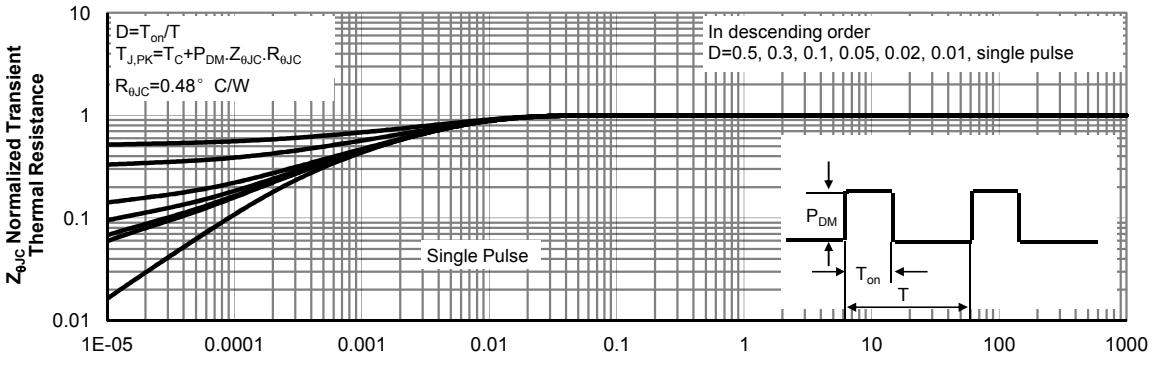


Figure 11: Normalized Maximum Transient Thermal Impedance for AOT2142L (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

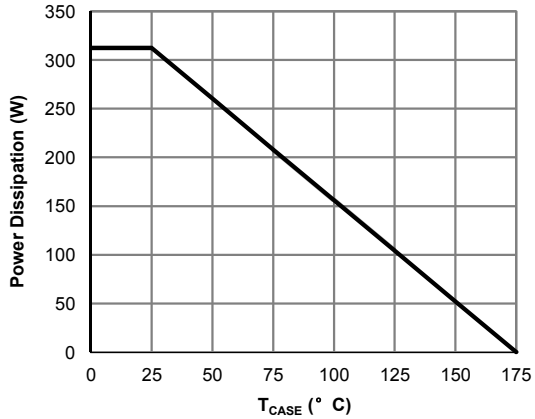


Figure 12: Power De-rating for AOT2142L (Note F)

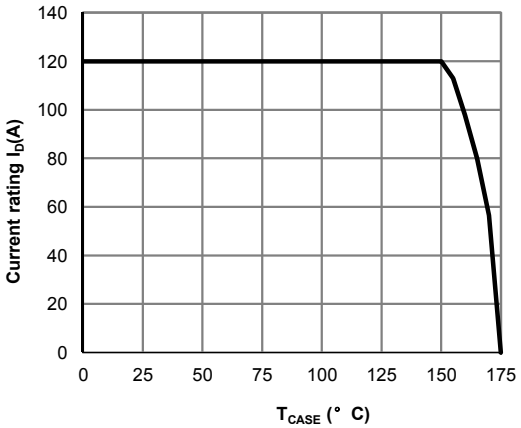


Figure 13: Current De-rating for AOT2142L (Note F)

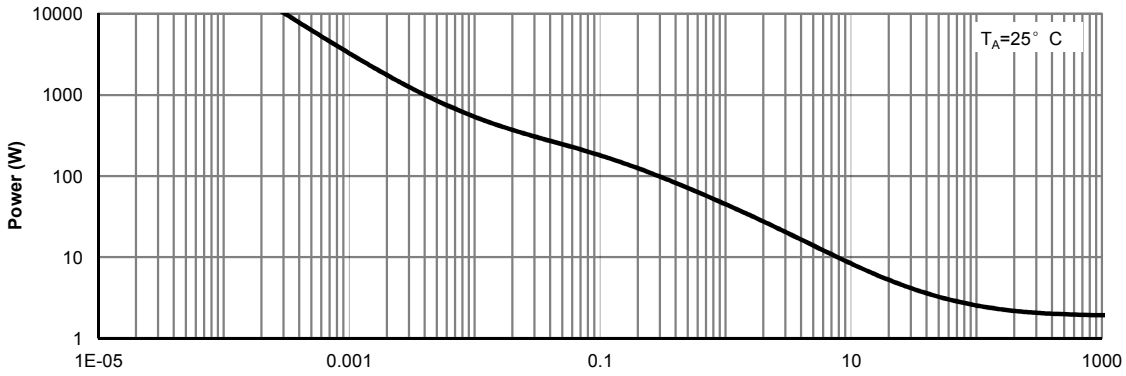


Figure 14: Single Pulse Power Rating Junction-to-Ambient (Note H)

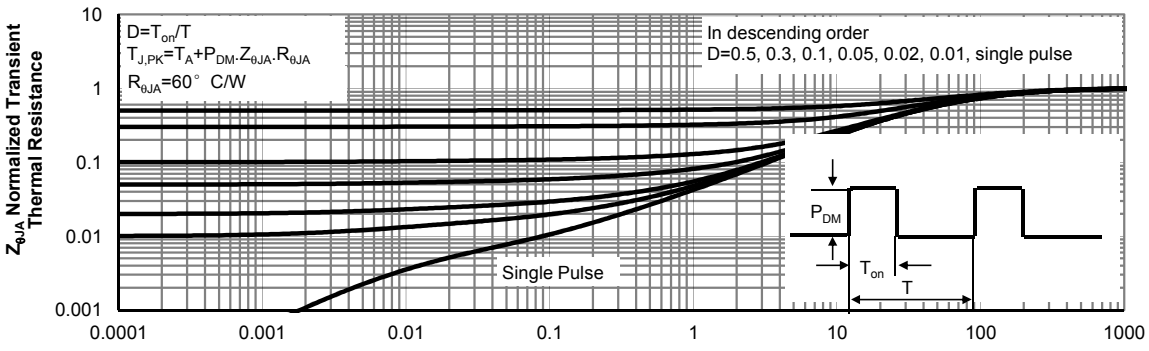


Figure 15: Normalized Maximum Transient Thermal Impedance (Note H)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

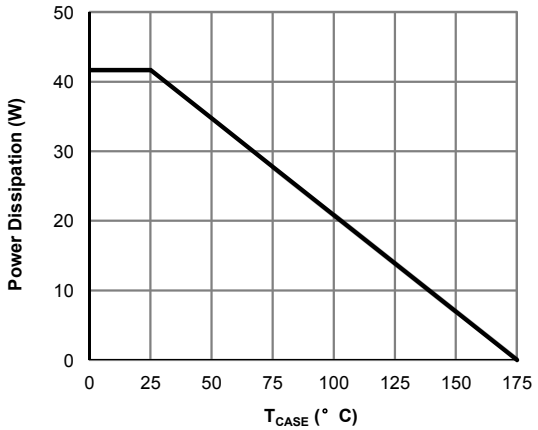


Figure 16: Power De-rating for AOTF2142L (Note F)

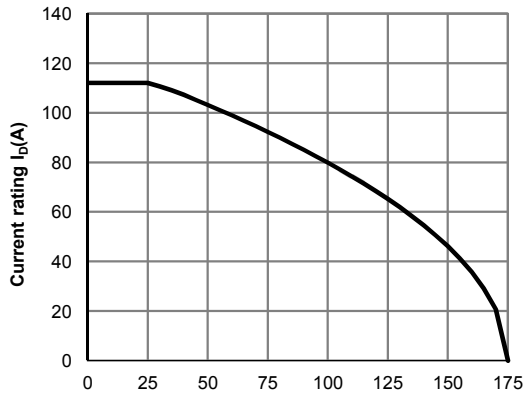
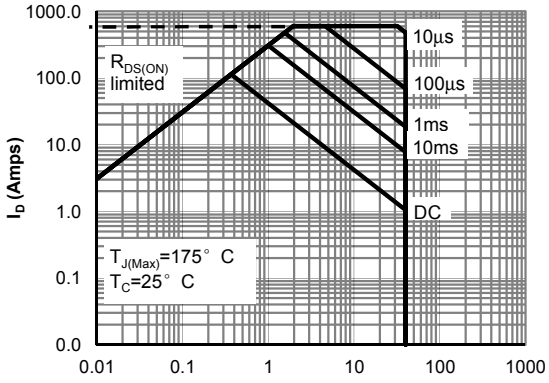


Figure 17: Current De-rating for AOTF2142L (Note F)



V_{GS}> or equal to 4.5V

Figure 18: Maximum Forward Biased Safe Operating Area for AOTF2142L (Note F)

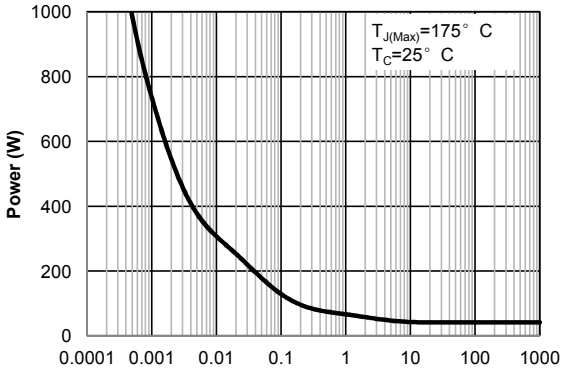


Figure 19: Single Pulse Power Rating Junction-to-Case for AOTF2142L (Note F)

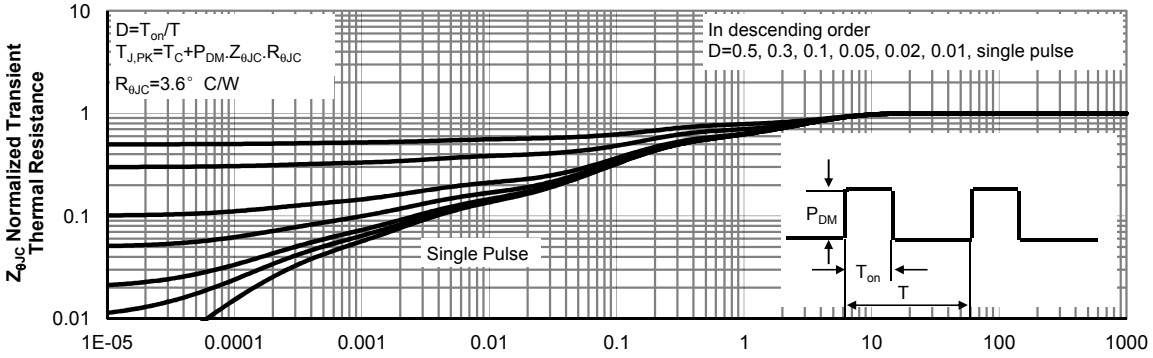
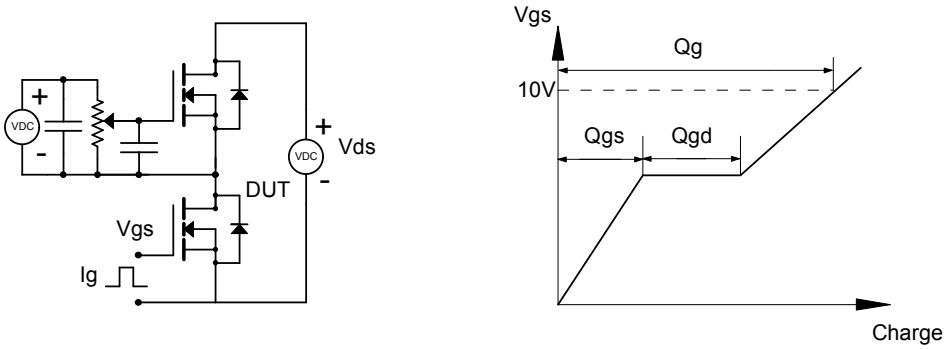
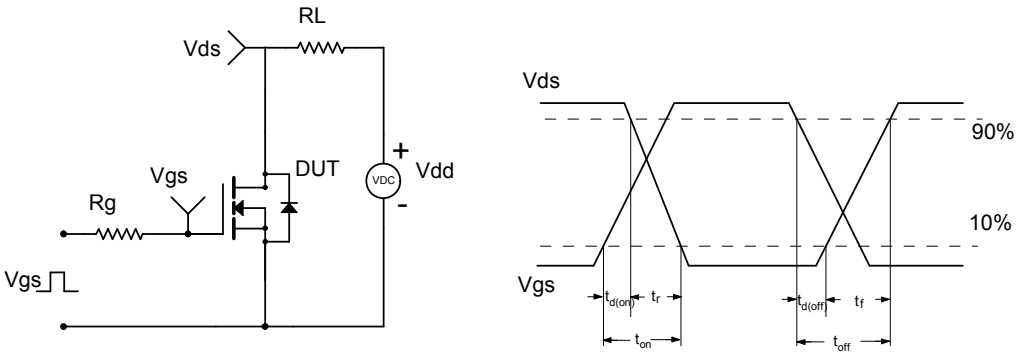


Figure 20: Normalized Maximum Transient Thermal Impedance for AOTF2142L (Note F)

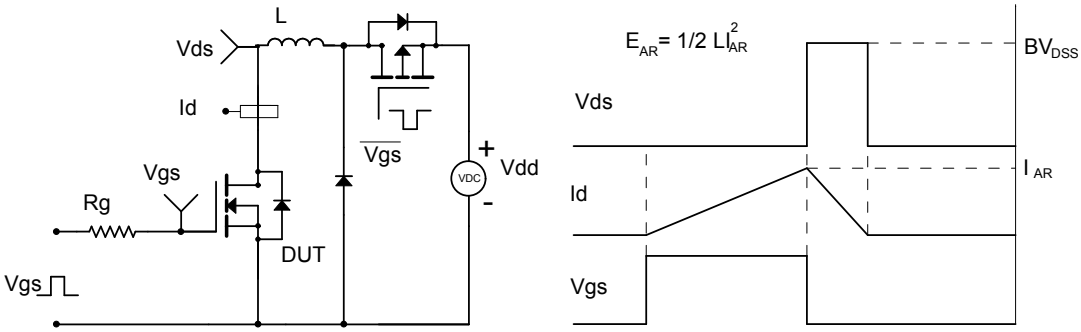
Gate Charge Test Circuit & Waveform



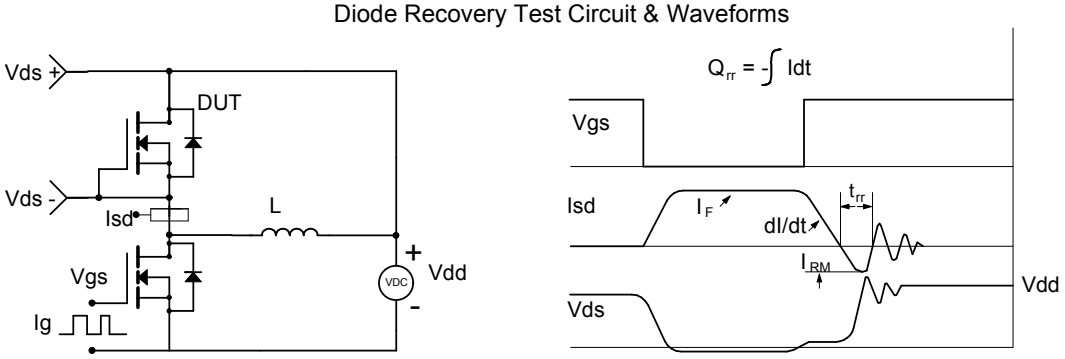
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